

SN54AHC05, SN74AHC05 HEX INVERTERS WITH OPEN-DRAIN OUTPUTS

SCLS357H – MAY 1997 – REVISED JULY 2003

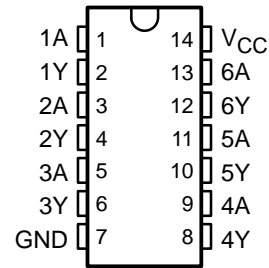
- Operating Range 2-V to 5.5-V V_{CC}
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

description/ordering information

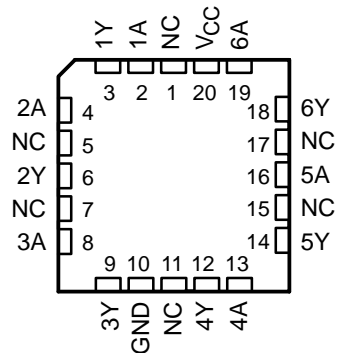
The 'AHC05 devices contain six independent inverters. These devices perform the Boolean function $Y = \bar{A}$.

The open-drain outputs require pullup resistors to perform correctly. They can be connected to other open-drain outputs to implement active-low wired-OR or active-high wired-AND functions.

SN54AHC05 . . . J OR W PACKAGE
SN74AHC05 . . . D, DB, DGV, N, OR PW PACKAGE
(TOP VIEW)



SN54AHC05 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

ORDERING INFORMATION

T_A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	PDIP – N	Tube	SN74AHC05N	SN74AHC05N
	SOIC – D	Tube	SN74AHC05D	AHC05
		Tape and reel	SN74AHC05DR	
	SSOP – DB	Tape and reel	SN74AHC05DBR	HA05
	TSSOP – PW	Tube	SN74AHC05PW	HA05
		Tape and reel	SN74AHC05PWR	
	TVSOP – DGV	Tape and reel	SN74AHC05DGVR	HA05
–55°C to 125°C	CDIP – J	Tube	SNJ54AHC05J	SNJ54AHC05J
	CFP – W	Tube	SNJ54AHC05W	SNJ54AHC05W
	LCCC – FK	Tube	SNJ54AHC05FK	SNJ54AHC05FK

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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 **TEXAS
INSTRUMENTS**

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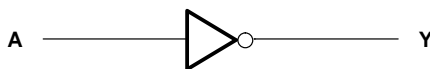
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**FUNCTION TABLE
(each inverter)**

INPUT A	OUTPUT Y
H	L
L	H

logic diagram, each inverter (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	-0.5 V to 7 V
Input voltage range, V_I (see Note 1)	-0.5 V to 7 V
Output voltage range, V_O (see Note 1)	-0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	-20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	± 20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	± 25 mA
Continuous current through V_{CC} or GND	± 50 mA
Package thermal impedance, θ_{JA} (see Note 2):	
D package	86°C/W
DB package	96°C/W
DGV package	127°C/W
N package	80°C/W
PW package	113°C/W
Storage temperature range, T_{stg}	-65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51-7.

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recommended operating conditions (see Note 3)

		SN54AHC05		SN74AHC05		UNIT
		MIN	MAX	MIN	MAX	
V _{CC}	Supply voltage	2	5.5	2	5.5	V
V _{IH}	High-level input voltage	V _{CC} = 2 V		1.5		V
		V _{CC} = 3 V		2.1		
		V _{CC} = 5.5 V		3.85		
V _{IL}	Low-level input voltage	V _{CC} = 2 V		0.5		V
		V _{CC} = 3 V		0.9		
		V _{CC} = 5.5 V		1.65		
V _I	Input voltage	0	5.5	0	5.5	V
V _O	Output voltage	0	V _{CC}	0	V _{CC}	V
I _{OL}	Low-level output current	V _{CC} = 2 V		50		μA
		V _{CC} = 3.3 V ± 0.3 V		4		
		V _{CC} = 5 V ± 0.5 V		8		
Δt/Δv	Input transition rise or fall rate	V _{CC} = 3.3 V ± 0.3 V		100		ns/V
		V _{CC} = 5 V ± 0.5 V		20		
T _A	Operating free-air temperature	-55	125	-40	85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC}	T _A = 25°C			SN54AHC05		SN74AHC05		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V _{OL}	I _{OL} = 50 μA	2 V			0.1	0.1	0.1	0.1	V	
		3 V			0.1	0.1	0.1			
		4.5 V			0.1	0.1	0.1			
	I _{OL} = 4 mA	3 V			0.36	0.5	0.44			
	I _{OL} = 8 mA	4.5 V			0.36	0.5	0.44			
I _I	V _I = 5.5 V or GND	0 V to 5.5 V			±0.1	±1*	±1	μA		
I _{CC}	V _I = V _{CC} or GND, I _O = 0	5.5 V			2	20	20	μA		
C _i	V _I = V _{CC} or GND	5 V			2.5	10	10	pF		

* On products compliant to MIL-PRF-38535, this parameter is not production tested at V_{CC} = 0 V.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T _A = 25°C			SN54AHC05		SN74AHC05		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t _{PLZ}	A	Y	C _L = 15 pF		2.9**	7.1**	1**	8.5**	1	8.5	ns
t _{PZL}					4**	7.1**	1**	8.5**	1	8.5	
t _{PLZ}	A	Y	C _L = 50 pF		4.7	10.6	1	12	1	12	ns
t _{PZL}					5.8	10.6	1	12	1	12	

** On products compliant to MIL-PRF-38535, this parameter is not production tested.

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**switching characteristics over recommended operating free-air temperature range,
V_{CC} = 5 V ± 0.5 V (unless otherwise noted) (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T _A = 25°C			SN54AHC05		SN74AHC05		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t _{PLZ}	A	Y	C _L = 15 pF	2.2*	5.5*	1*	6.5*	1	6.5	ns	
t _{PZL}				2.9*	5.5*	1*	6.5*	1	6.5		
t _{PLZ}	A	Y	C _L = 50 pF	3.4	7.5	1	8.5	1	8.5	ns	
t _{PZL}				4.2	7.5	1	8.5	1	8.5		

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

operating characteristics, V_{CC} = 5 V, T_A = 25°C

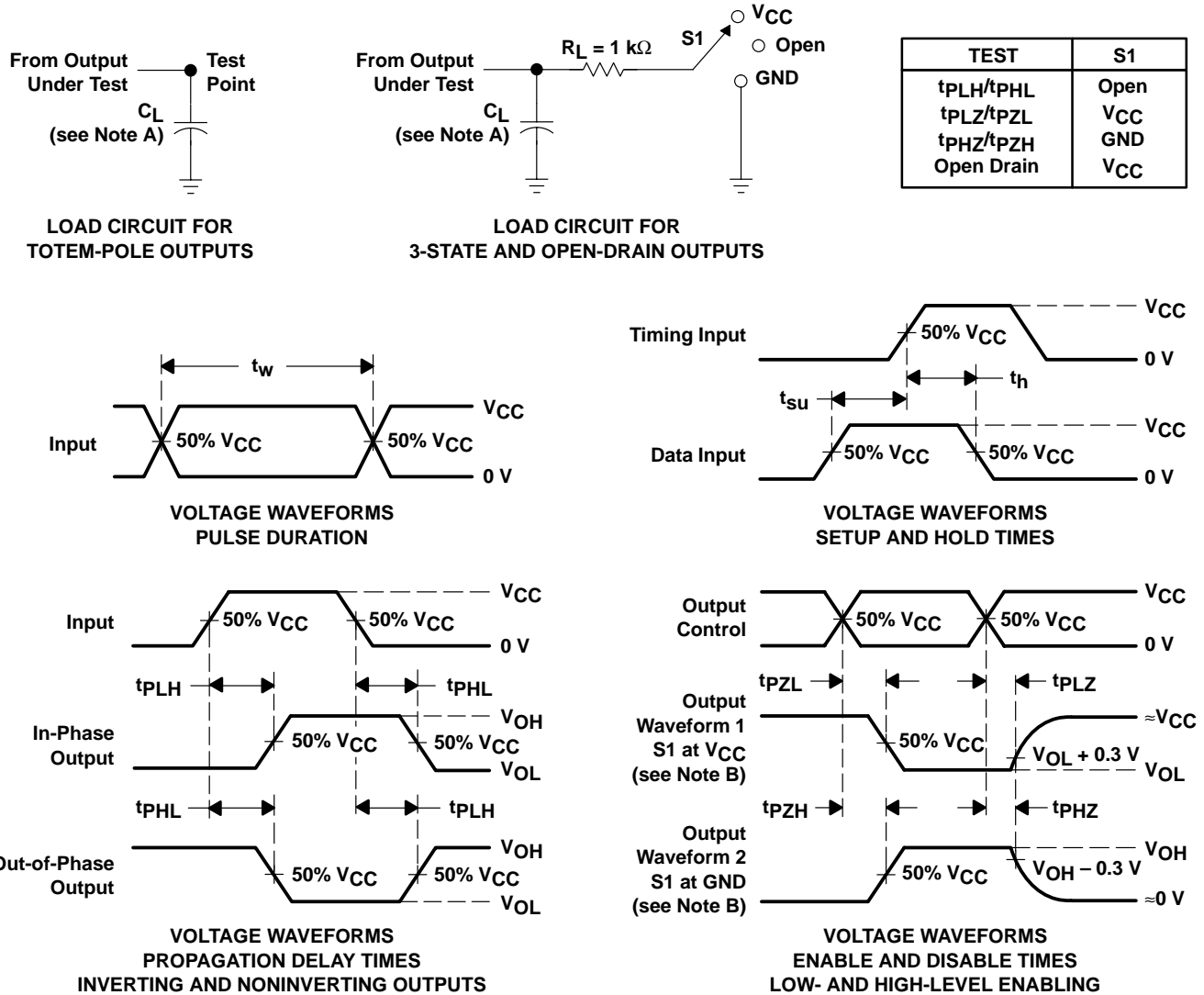
PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd} Power dissipation capacitance	No load, f = 1 MHz	3	pF

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PARAMETER MEASUREMENT INFORMATION



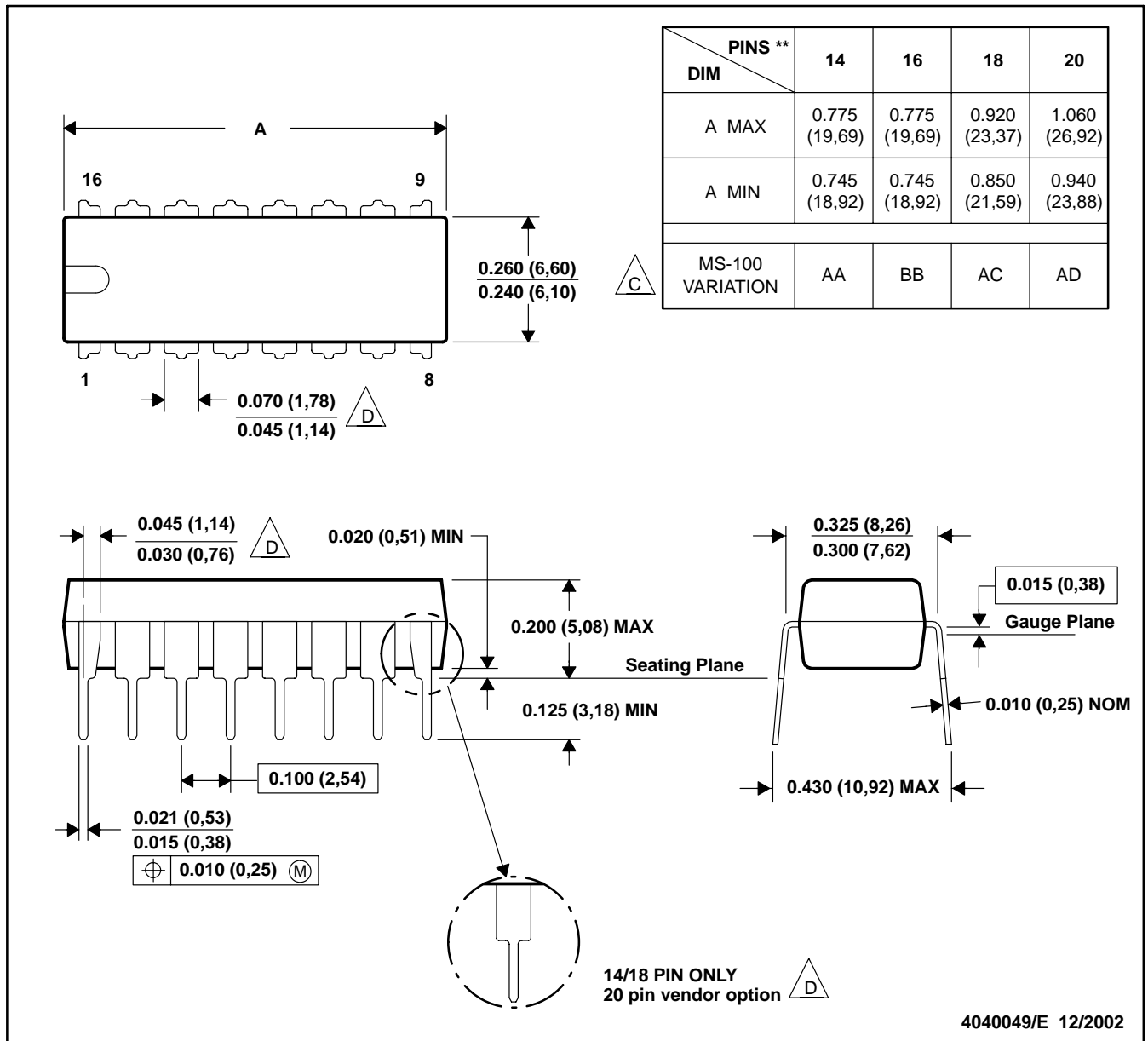
- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is high except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is low except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, $Z_O = 50\ \Omega$, $t_r \leq 3$ ns, $t_f \leq 3$ ns.
 D. The outputs are measured one at a time with one input transition per measurement.
 E. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 D The 20 pin end lead shoulder width is a vendor option, either half or full width.

DGV (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

24 PINS SHOWN

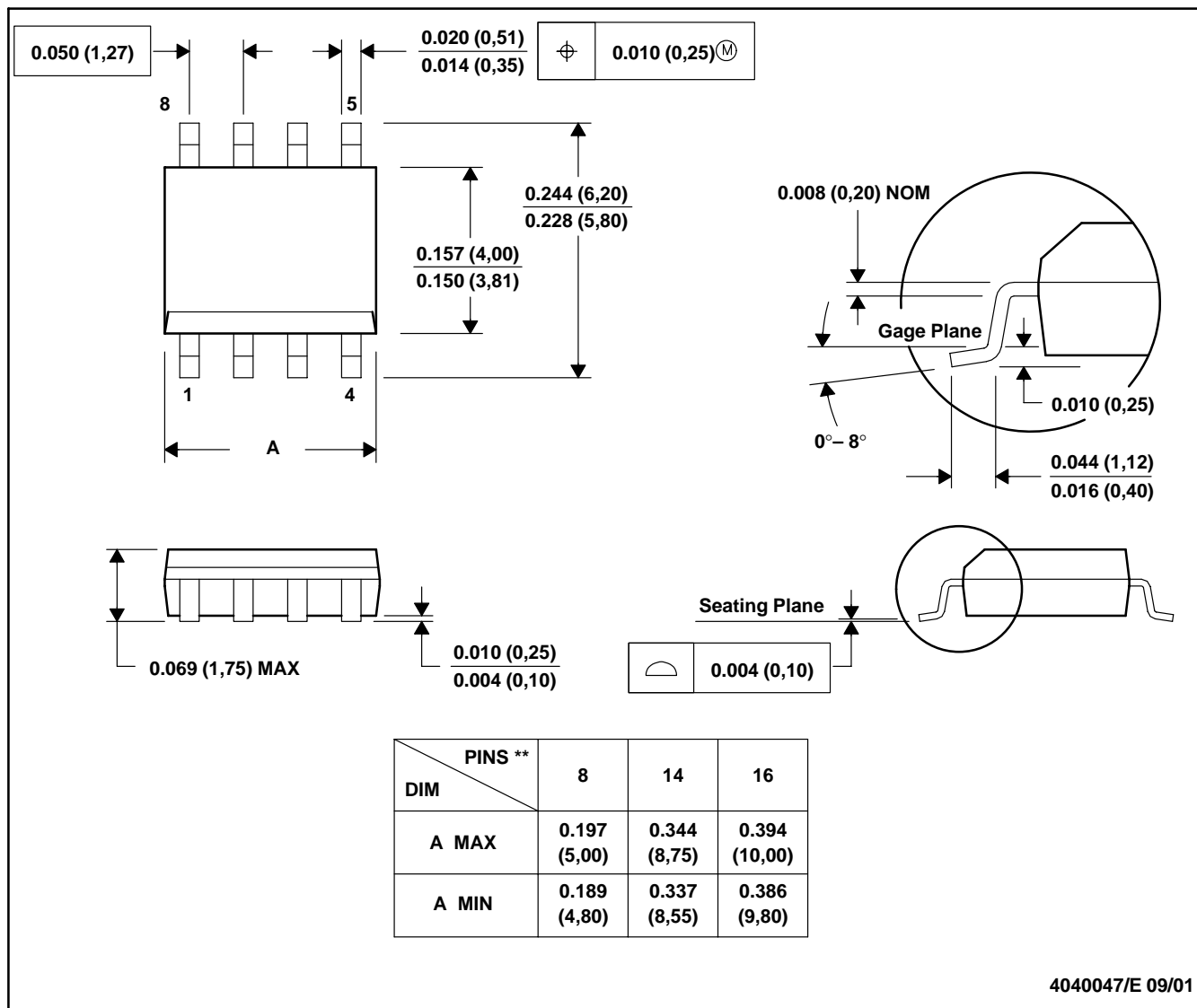


- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
 D. Falls within JEDEC: 24/48 Pins – MO-153
 14/16/20/56 Pins – MO-194

D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN



4040047/E 09/01

- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).
 D. Falls within JEDEC MS-012

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-150

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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